

11-18-1999

PATENT DOCKET NO: AB-879 US

U.S. DEPARTMENT OF COMMERCE

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Patent and Trademark Office



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To the Honorable Commissioner of Patents and Trademarks. Please record the attached original documents or copy thereof.

1. Name of conveying party(ies):

(a) Cha, Gi-Won; Lim, Kyu-Nam

(b)

(c)

Additional name(s) of conveying party(ies) attached?

☐ Yes☒ No

2. Name and address of receiving party(ies):

Name: Samsung Electronics Co., Ltd.Street Address: 416 Maetan-dong, Paldal-guCity: Suwon-cityCountry: Kyungki-do, Republic of KoreaJC575 U.S. PTO
09/436089
11/08/99

3. Nature of Conveyance

☒ Assignment☐ Merger☐ Security Agreement☐ Change of Name☐ Other _____Execution Date: October 27, 1999

Name and address of receiving party(ies):

Name:

Street Address:

City:

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Country:

4. Application number(s) or patent number(s)

If this document is being filed together with a new application, the execution date of the application is: October 27, 1999

A. Patent Application No.(s) -

Title **Semiconductor Memory Device With A Multi-Bank Structure**

B. Patent No.(s)

09/436089

Additional numbers attached?

☐ Yes☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: David T. MillersInternal Address: SKJERVEN, MORRILL MacPHERSON,FRANKLIN & FRIEL LLPStreet Address: 25 METRO DRIVE, SUITE 700City SAN JOSE State CA ZIP 951106. Total number of applications and patents involved: 17. Total fee (37 CFR 3.41): \$40.00☒ Authorized to be charged to Deposit Account 19-2386☒ Charge Deposit Account 19-2386 for any additional fees required for this conveyance and credit deposit account 19-2386 any amounts overpaid

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8. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

David T. Millers

37,396

Name of Person Signing

David T. Millers

Signature

11-8-99

Date

Total number of pages comprising cover sheet: 1

ASSIGNMENT

For good and valuable consideration, receipt of which is hereby acknowledged, we

Cha, Gi-Won of 727-202, Hyundai Apt., 989-2, Youngtong-dong,
Paldal-ku, Suwon, Kyunggi-do, Republic of Korea

Lim, Kyu-Nam of 7-1, Nongseo-ri, Kiheung-eub, Yongin-shi,
Kyunggi-do, Republic of Korea

hereby sell, assign and transfer to Samsung Electronics Co., Ltd., a Korean corporation, having a place of business at 416, Maetan-dong, Paldal-gu, Suwon-city, Kyunggi-do, Republic of Korea, its successors and assigns, the entire right, title and interest throughout the world in our invention in

Semiconductor Memory Device With A Multi-Bank Structure

for which we have executed a United States patent application on or about the date of this assignment, and all patent applications and patents of every country for said invention, including divisions, reissues, continuations and extensions thereof, and all rights of priority resulting from the filing of said applications; we authorize the above-named assignee to apply for patents of foreign countries for said invention, and to claim all rights of priority without further authorization from us; we agree to execute all papers useful in connection with said United States and foreign applications, and generally to do everything possible to aid said assignee, their successors, assigns and nominees, at their request and expense, in obtaining and enforcing patents for said invention in all countries; and we request the Commissioner of Patents and Trademarks to issue all patents granted for said invention to the above-named assignee, its successors and assigns.

Executed this 27 day of 10, 1999.

CHA GIWON
Cha, Gi-Won

Executed this 27 day of 10, 1999.

LIM, KYU NAM
Lim, Kyu-Nam